

User Registration

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| PCN Issue Date: 3/2/2017 | | | Effective Date: 6/7/2017 | | | | |
|---|---|------------|--------------------------|------------|--|--|--|
| Title: Si838x OTP Robustness Enhancement | | | | | | | |
| PCN Type: | | | | | | | |
| □ Datasheet | | 🛛 Foundry | | □ Packing | | | |
| □ Product Revision | | □ Assembly | | □ Labeling | | | |
| □ Discontinuance | | ⊠ Test | | □ Other | | | |
| Last Order Date: NA | | | | | | | |
| PCN Details | | | | | | | |
| Description of | Change: | | | | | | |
| | Silicon Labs is pleased to announce an enhancement to the robustness of the OTP (One Time | | | | | | |
| Programming) circuit utilized in this product. There are no changes made in the logic and/or any functional parts of the product die. | | | | | | | |
| Reason for Change: | | | | | | | |
| The physical layout of Si838x OTP circuit was changed to improve robustness. | | | | | | | |
| Impact on Form, Fit, Function, Quality, Reliability: There is no impact on form, fit and Silicon Labs is pleased to announce an enhancement to the robustness of the OTP (One Time Programming) circuit utilized in this product. There are no changes made in the logic and/or any functional parts of the product die.function. All quality and reliability checks have been done and show no impact. | | | | | | | |
| Product Identification: | | | | | | | |
| SI8380S-IU | SI8380S-IUR | | | | | | |
| SI8380P-IU | SI8380P-IUR | | | | | | |
| SI8382P-IU | SI8382P-IUR SI8384P-IUR | | | | | | |
| SI8384P-IU SI8388P-IU | SI8384P-IUR SI8388P-IUR | | | | | | |
| SI8380PS-IU | SI8388P-IUR SI8380PS-IUR | | | | | | |
| SI8382PS-IU | | | | | | | |
| SI8384PS-IU | | | | | | | |
| SI8380PM-IU | | | | | | | |
| SI8382PM-IU | | | | | | | |
| SI8384PM-IU | SI8384PM-IUR | | | | | | |
| SI8380PF-IU | SI8380PF-IUR | | | | | | |
| SI8382PF-IU | SI8382PF-IUR | | | | | | |
| SI8384PF-IU | SI8384PF-IUR | | | | | | |
| Last Date of Un | Last Date of Unchanged Product: 6/7/2017 | | | | | | |
| Qualification Samples: Samples available upon request | | | | | | | |

W7206F1 Process Change Notice Form rev AAB

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Specific conditions of acceptance of this change will be considered on a case by case basis if written notice is submitted within 30 days of this notice. To request further data or inquire about this notification, please contact your local Silicon Labs sales representative. A list of Silicon Labs sales representatives is available at <u>www.silabs.com</u>.

In some cases rejection of a change notice may impact Silicon Labs product pricing, delivery, quality, or reliability.

Customer Early Acceptance Sign Off:

Customers may approve early PCN acceptance by completing the information below:

Early Acceptance: Date: _____

Name:

Company:

Email your early Acceptance approval to: <u>katherine.haggar@silabs.com</u>

Qualification Data:

Please see attached qualification report.



Appendix

Si838x 20-Pin QSOP AEC-Q100 Qualification Report

W7101F1 - Product Qualification Report Record Rev. H

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| Part Rev A, Vanguard Fabrication, UTACTH Assembly except as noted | | | | | | | |
|---|---------------------------------|----------------|---------|--------------|-------|---------|--------|
| | | | | Fail/Pass or | Notes | | Chatra |
| Test Name | Test Condition | Qualification | Start | End | Notes | Summary | Status |
| | elerated Environment Stres | is lests | 1 | | | | |
| HAST | JA110 | | Q038511 | | 1 | | |
| | 130°C, 85%RH | 3 lots, N=>77 | Q039657 | 0/85 | 1 | 3 lots | Pass |
| | Vcc=5.5V, 96 hours | | Q039656 | 0/85 | 1 | 0/255 | |
| UHAST | JA110 | | Q038513 | 0/85 | 1 | | |
| | 130°C, 85%RH | 3 lots, N=>77 | Q039659 | 0/85 | 1 | 3 lots | Pass |
| | Vcc=5.5V, 96 hours | | Q039658 | 0/85 | 1 | 0/255 | |
| Temp Cycle | JA104 | | Q038407 | 0/85 | 1 | | |
| | Cond C: -65°C to 150°C | 3 lots, N=>77 | Q039660 | 0/85 | 1 | 3 lots | Pass |
| | 500 cycles | | Q039661 | 0/85 | 1 | 0/255 | |
| HTSL | JA103 | | | | | | |
| | 150°C, 1000hr | 1 lot, N=>45 | Q038154 | 0/50 | 1 | 1 lots | Pass |
| | | | | | | 0/50 | |
| Test Group B – Acc | elerated Lifetime Simulation | n Tests | | | | | |
| HTOL | JA108 | | Q038519 | 0/100 | | | |
| | T _J ≥ 125°C, Dynamic | 3 lots, N=>77 | Q039664 | 0/81 | | 3 lots | Pass |
| | Vcc=5.5V, 1000 hours | | Q039665 | 0/100 | | 0/281 | |
| ELFR | AEC-Q100-008 | | Q038177 | 0/822 | | | |
| | T _J ≥ 125°C, Dynamic | 3 lots, N=>800 | Q039663 | 0/819 | | 3 lots | Pass |
| | Vcc=5.5V, 48 hours | | Q039662 | 0/820 | | 0/2461 | |
| Test Group C - Pac | kage Assembly Integrity Te | sts | | | | | |
| Wire Bond Shear | AEC-Q100-001 | | 718170 | 0/6 | | | |
| | | 5 units, N=>30 | 721740 | 0/6 | | 3 lots | Pass |
| | | | 721741 | 0/6 | | 0/18 | |
| Wire Bond Pull | M-STD-883 | | 718170 | 0/6 | | | |
| | Performed post-TC | 5 units, N=>30 | 721740 | 0/6 | | 3 lots | Pass |
| | | | 721741 | 0/6 | | 0/18 | |
| Physical Dimension | s JB100 | | 718170 | 0/30 | | | |
| - | | 3 lots, N=>10 | 721740 | 0/30 | | 3 lots | Pass |
| | | | 721741 | 0/30 | | 0/90 | |
| Solderability | JB102 | | 718170 | 0/10 | | 0.00 | |
| | | 1 lot, N=>15 | 721740 | 0/10 | | 3 lots | Pass |
| | | 1100, N=>15 | 721740 | 0/10 | | 0/30 | Fass |
| | | | 721741 | 0/10 | | 0/50 | |

Approved by: Noel Arguello

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Si838x 20-Pin QSOP AEC-Q100 Qualification Report

💕 W7101F1 - Product Qualification Report Record 👘 Rev. H

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| Part Rev A, Vanguard Fabrication, UTACTH Assembly except as noted | | | | | | | |
|---|---|---------------|--------------------|---------------------|-------|---------|----------|
| Test Name Test Group E – Elec | Test Condition | Qualification | Lot ID or Start | Fail/Pass or End | Notes | Summary | Status |
| ESD-HBM | AEC-Q100-002 | 1 lot, N=>3 | Q037537 | | | | Class 3A |
| ESD-CDM | AEC-Q100-011 | 1 lot, N=>3 | Q037536 | | | | Class C5 |
| Latch Up | AEC-Q100-004 ±200mA Overvoltage = 8.25∨ | 1 lot, N=>6 | Q37539 | 125 °C | | | Pass |

Notes:

1. Parts are Pre-conditioned at MSL2/260°C

| R SI8380PM-IU/R | SI8380PS-IU/R | SI8380S-IU/R |
|------------------|------------------|--------------------------------|
| R SI8382PM-IU/R | SI8382PS-IU/R | SI8384P-IU/R |
| /R SI8384PS-IU/R | SI8388P-IU/R | |
| 1 | /R SI8382PM-IU/R | /R SI8382PM-IU/R SI8382PS-IU/R |

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